NOTES:

1. All dimensioning and tolerancing conform to ANSI Y14.5-1982.

2. Datum plane H located at mold parting line and coincident with lead, where lead exits plastic body at bottom of parting line.

3. Datums A-B and D to be determined at centerline between leads where leads exit plastic body at datum plane H.

4. Dimensions D1 and E1 do not include mold protrusion. Allowable mold protrusion is 0.254mm on D1 and E1 dimensions.

5. These dimensions to be determined at datum plane H.

6. Package top dimensions are smaller than bottom dimensions and top of package will not overhang bottom of package.

7. Dimension b does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm total in excess of the b dimension at maximum material condition. Dambar cannot be located on the lower radius or the foot.


9. This outline conforms to JEDEC publication 95 registration MS-026, variation ACB.

10. Dimensions in ( ) are for reference only.

11. The corners of the exposed heatspreader may appear different due to the presence of the tiebars.

MS-026, variation ACB.